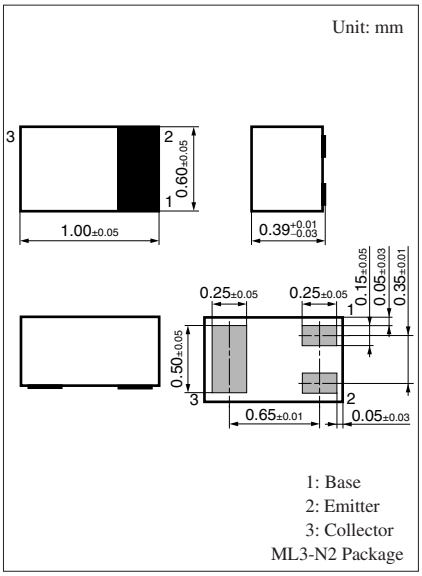
2SC5829

Silicon NPN epitaxial planar type

For high speed switching

■ Features

- Allowing the small current and low voltage operation
- High transition frequency f_T
- Suitable for high-density mounting and downsizing of the equipment for Ultraminiature leadless package
  0.6 mm × 1.0 mm (height 0.39 mm)



Marking Symbol: X

■ Absolute Maximum Ratings $T_a = 25°C$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V_{CBO}	10	V
Collector-emitter voltage (Base open)	V_{CEO}	7	V
Emitter-base voltage (Collector open)	V_{EBO}	2	V
Collector current	I_C	10	mA
Collector power dissipation	P_C	50	mW
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	−55 to +150	°C

■ Electrical Characteristics $T_a = 25°C \pm 3°C$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base cutoff current (Emitter open)	I_{CBO}	V_{CB} = 10 V, I_E = 0			1	μA
Emitter-base cutoff current (Collector open)	I_{EBO}	V_{EB} = 1.5 V, I_C = 0			1	μA
Forward current transfer ratio	h_{FE}	V_{CE} = 1 V, I_C = 1 mA	100		200	—
Transition frequency	f_T	V_{CE} = 1 V, I_C = 1 mA, f = 0.8 GHz		4		GHz
Collector output capacitance (Common base, input open circuited)	C_{ob}	V_{CB} = 1 V, I_E = 0, f = 1 MHz		0.4		pF
Forward transfer gain	$\|S_{21e}\|^2$	V_{CE} = 1 V, I_C = 1 mA, f = 0.8 GHz		6		dB
Maximum unilateral power gain	G_{UM}	V_{CE} = 1 V, I_C = 1 mA, f = 0.8 GHz		15		dB
Noise figure	NF	V_{CE} = 1 V, I_C = 1 mA, f = 0.8 GHz		3.5		dB

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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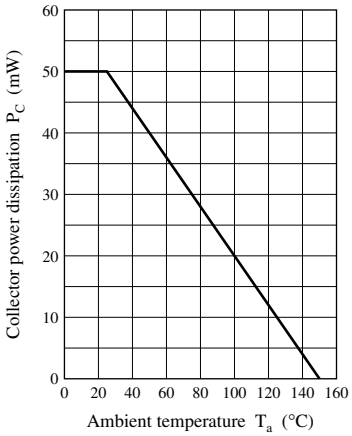
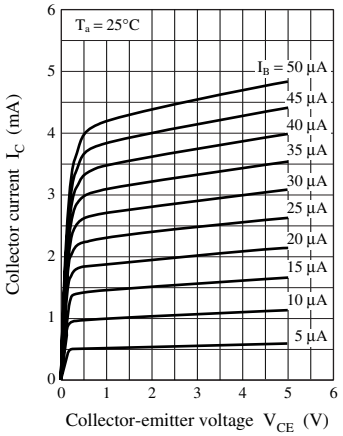
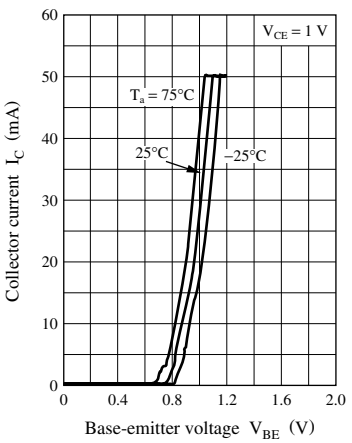
P_C — T_a



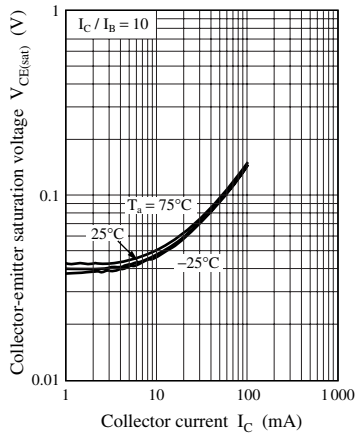
I_C — V_{CE}



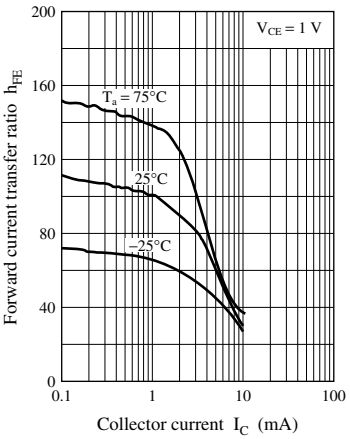
I_C — V_{BE}



$V_{CE(sat)}$ — I_C



h_{FE} — I_C



C_{ob} — V_{CB}